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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	40 MIPs
Connectivity	I ² C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	85
Program Memory Size	64KB (22K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 32x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24hj64gp210at-i-pt

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5.4.1 PROGRAMMING ALGORITHM FOR FLASH PROGRAM MEMORY

The user can program one row of program Flash memory at a time. To do this, it is necessary to erase the 8-row erase page that contains the desired row. The general process is:

- 1. Read eight rows of program memory (512 instructions) and store in data RAM.
- 2. Update the program data in RAM with the desired new data.
- 3. Erase the page (see Example 5-1):
 - a) Set the NVMOP bits (NVMCON<3:0>) to '0010' to configure for block erase. Set the ERASE (NVMCON<6>) and WREN (NVMCON<14>) bits.
 - b) Write the starting address of the page to be erased into the TBLPAG and W registers.
 - Perform a dummy table write operation (TBLWTL) to any address within the page that needs to be erased.
 - d) Write 0x55 to NVMKEY.
 - e) Write 0xAA to NVMKEY.
 - f) Set the WR bit (NVMCON<15>). The erase cycle begins and the CPU stalls for the duration of the erase cycle. When the erase is done, the WR bit is cleared automatically.

- 4. Write the first 64 instructions from data RAM into the program memory buffers (see Example 5-2).
- 5. Write the program block to Flash memory:
 - Set the NVMOP bits to '0001' to configure for row programming. Clear the ERASE bit and set the WREN bit.
 - b) Write 0x55 to NVMKEY.
 - c) Write 0xAA to NVMKEY.
 - d) Set the WR bit. The programming cycle begins and the CPU stalls for the duration of the write cycle. When the write to Flash memory is done, the WR bit is cleared automatically.
- Repeat steps 4 and 5, using the next available 64 instructions from the block in data RAM by incrementing the value in TBLPAG, until all 512 instructions are written back to Flash memory.

For protection against accidental operations, the write initiate sequence for NVMKEY must be used to allow any erase or program operation to proceed. After the programming command has been executed, the user must wait for the programming time until programming is complete. The two instructions following the start of the programming sequence should be NOPS, as shown in Example 5-3.

EXAMPLE 5-1: ERASING A PROGRAM MEMORY PAGE

```
; Set up NVMCON for block erase operation
               #0x4042, W0
       MOV
               WO, NVMCON
                                             ; Initialize NVMCON
; Init pointer to row to be ERASED
       MOV
               #tblpage(PROG ADDR), W0
                                             ; Initialize PM Page Boundary SFR
       MOV
               WO, TBLPAG
               #tbloffset(PROG ADDR), W0
                                             ; Initialize in-page EA<15:0> pointer
       TBLWTL WO, [WO]
                                             ; Set base address of erase block
       DISI
              #5
                                             ; Block all interrupts with priority <7
                                             ; for next 5 instructions
       MOV
               #0x55, W0
               WO, NVMKEY
                                             ; Write the 55 key
       MOV
       MOV
               #0xAA, W1
       MOV
               W1, NVMKEY
                                             ; Write the AA key
               NVMCON, #WR
       BSET
                                             ; Start the erase sequence
       NOP
                                             ; Insert two NOPs after the erase
                                             : command is asserted
```

Note: A program memory page erase operation is set up by performing a dummy table write (TBLWTL) operation to any address within the page. This methodology is different from the page erase operation on depth 2005/33E devices in which the erase

dsPIC30F/33F devices in which the erase page was selected using a dedicated pair of registers (NVMADRU and NVMADR).

REGISTER 7-12: IEC2: INTERRUPT ENABLE CONTROL REGISTER 2

R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
T6IE	DMA4IE	_	OC8IE	OC7IE	OC6IE	OC5IE	IC6IE
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
IC5IE	IC4IE	IC3IE	DMA3IE	C1IE	C1RXIE	SPI2IE	SPI2EIE
bit 7							bit 0

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **T6IE:** Timer6 Interrupt Enable bit 1 = Interrupt request enabled

Legend:

0 = Interrupt request not enabled

bit 14 DMA4IE: DMA Channel 4 Data Transfer Complete Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 13 Unimplemented: Read as '0'

bit 12 OC8IE: Output Compare Channel 8 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 11 OC7IE: Output Compare Channel 7 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 10 OC6IE: Output Compare Channel 6 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 9 OC5IE: Output Compare Channel 5 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 8 IC6IE: Input Capture Channel 6 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 7 IC5IE: Input Capture Channel 5 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 6 IC4IE: Input Capture Channel 4 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 5 IC3IE: Input Capture Channel 3 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 4 DMA3IE: DMA Channel 3 Data Transfer Complete Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 3 C1IE: ECAN1 Event Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

REGISTER 7-20: IPC5: INTERRUPT PRIORITY CONTROL REGISTER 5

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		IC8IP<2:0>		_		IC7IP<2:0>	
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		AD2IP<2:0>		_		INT1IP<2:0>	
bit 7						_	bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 IC8IP<2:0>: Input Capture Channel 8 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

.

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 IC7IP<2:0>: Input Capture Channel 7 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

.

.

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as '0'

bit 6-4 AD2IP<2:0>: ADC2 Conversion Complete Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **INT1IP<2:0>:** External Interrupt 1 Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

REGISTER 7-25: IPC10: INTERRUPT PRIORITY CONTROL REGISTER 10

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		OC7IP<2:0>		_		OC6IP<2:0>	
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		OC5IP<2:0>		_		IC6IP<2:0>	
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 Unimplemented: Read as '0'

bit 14-12 OC7IP<2:0>: Output Compare Channel 7 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11 Unimplemented: Read as '0'

bit 10-8 OC6IP<2:0>: Output Compare Channel 6 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 7 Unimplemented: Read as '0'

bit 6-4 OC5IP<2:0>: Output Compare Channel 5 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3 Unimplemented: Read as '0'

bit 2-0 IC6IP<2:0>: Input Capture Channel 6 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

001 = Interrupt is priority 1

000 = Interrupt source is disabled

NOTES:

14.0 INPUT CAPTURE

- **Note 1:** This data sheet summarizes the features of the PIC24HJXXXGPX06A/X08A/X10A family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the "dsPIC33F/PIC24H Family Reference Manual", Section 12. "Input Capture" (DS70198), which is available from the Microchip web site (www.microchip.com).
 - 2: Some registers and associated bits described in this section may not be available on all devices. Refer to Section 4.0 "Memory Organization" in this data sheet for device-specific register and bit information.

The input capture module is useful in applications requiring frequency (period) and pulse measurement. PIC24HJXXXGPX06A/X08A/X10A support up to eight input capture channels.

The input capture module captures the 16-bit value of the selected Time Base register when an event occurs at the ICx pin. The events that cause a capture event are listed below in three categories:

- · Simple Capture Event modes:
 - Capture timer value on every falling edge of input at ICx pin
 - Capture timer value on every rising edge of input at ICx pin

- · Capture timer value on every edge (rising and falling)
- · Prescaler Capture Event modes:
 - Capture timer value on every 4th rising edge of input at ICx pin
 - Capture timer value on every 16th rising edge of input at ICx pin

Each input capture channel can select between one of two 16-bit timers (Timer2 or Timer3) for the time base. The selected timer can use either an internal or external clock.

Other operational features include:

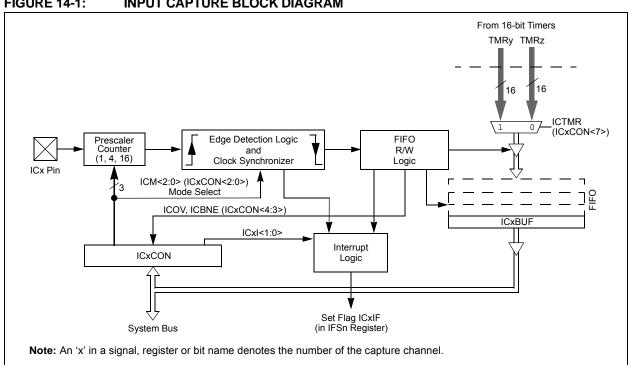
- · Device wake-up from capture pin during CPU Sleep and Idle modes
- · Interrupt on input capture event

Note:

- · 4-word FIFO buffer for capture values
 - Interrupt optionally generated after 1, 2, 3 or 4 buffer locations are filled
- · Input capture can also be used to provide additional sources of external interrupts.

Only IC1 and IC2 can trigger a DMA data transfer. If DMA data transfers are required, the FIFO buffer size must be set to 1 (ICI < 1:0 > = 00).

FIGURE 14-1: INPUT CAPTURE BLOCK DIAGRAM



15.0 OUTPUT COMPARE

Note 1: This data sheet summarizes the features of the PIC24HJXXXGPX06A/X08A/X10A families of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the "dsPIC33F/PIC24H Family Reference Manual", Section 13. "Output Compare" (DS70209), which is available on the Microchip web site (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to Section 4.0 "Memory Organization" in this data sheet for device-specific register and bit information.

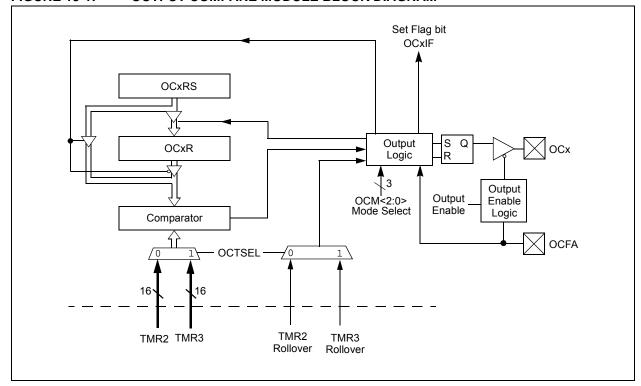
The output compare module can select either Timer2 or Timer3 for its time base. The module compares the value of the timer with the value of one or two Compare registers depending on the operating mode selected.

The state of the output pin changes when the timer value matches the Compare register value. The output compare module generates either a single output pulse, or a sequence of output pulses, by changing the state of the output pin on the compare match events. The output compare module can also generate interrupts on compare match events.

The output compare module has multiple operating modes:

- · Active-Low One-Shot mode
- · Active-High One-Shot mode
- · Toggle mode
- · Delayed One-Shot mode
- · Continuous Pulse mode
- · PWM mode without Fault Protection
- · PWM mode with Fault Protection

FIGURE 15-1: OUTPUT COMPARE MODULE BLOCK DIAGRAM



16.3 SPI Control Registers

REGISTER 16-1: SPIXSTAT: SPIX STATUS AND CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
SPIEN	_	SPISIDL	_	_	_	_	_
bit 15							bit 8

U-0	R/C-0	U-0	U-0	U-0	U-0	R-0	R-0
_	SPIROV	_	_	_	_	SPITBF	SPIRBF
bit 7							bit 0

Legend:C = Clearable bitR = Readable bitW = Writable bitU = Unimplemented bit, read as '0'-n = Value at POR'1' = Bit is set'0' = Bit is clearedx = Bit is unknown

bit 15 SPIEN: SPIx Enable bit

1 = Enables module and configures SCKx, SDOx, SDIx and \overline{SSx} as serial port pins

0 = Disables module

bit 14 **Unimplemented:** Read as '0' bit 13 **SPISIDL:** Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12-7 Unimplemented: Read as '0'

bit 6 SPIROV: Receive Overflow Flag bit

1 = A new byte/word is completely received and discarded. The user software has not read the

previous data in the SPIxBUF register

0 = No overflow has occurred

bit 5-2 **Unimplemented:** Read as '0'

bit 1 SPITBF: SPIx Transmit Buffer Full Status bit

1 = Transmit not yet started, SPIxTXB is full 0 = Transmit started, SPIxTXB is empty

Automatically set in hardware when CPU writes SPIxBUF location, loading SPIxTXB.

Automatically cleared in hardware when SPIx module transfers data from SPIxTXB to SPIxSR.

bit 0 SPIRBF: SPIx Receive Buffer Full Status bit

1 = Receive complete, SPIxRXB is full

0 = Receive is not complete, SPIxRXB is empty

Automatically set in hardware when SPIx transfers data from SPIxSR to SPIxRXB.

Automatically cleared in hardware when core reads SPIxBUF location, reading SPIxRXB.

REGISTER 17-1: I2CxCON: I2Cx CONTROL REGISTER (CONTINUED)

bit 5 **ACKDT:** Acknowledge Data bit (when operating as I²C master, applicable during master receive)

Value that will be transmitted when the software initiates an Acknowledge sequence.

1 = Send NACK during Acknowledge0 = Send ACK during Acknowledge

bit 4 ACKEN: Acknowledge Sequence Enable bit

(when operating as I²C master, applicable during master receive)

1 = Initiate Acknowledge sequence on SDAx and SCLx pins and transmit ACKDT data bit. Hardware clear at end of master Acknowledge sequence.

0 = Acknowledge sequence not in progress

bit 3 RCEN: Receive Enable bit (when operating as I²C master)

1 = Enables Receive mode for I^2C . Hardware clear at end of eighth bit of master receive data byte.

0 = Receive sequence not in progress

bit 2 **PEN:** Stop Condition Enable bit (when operating as I²C master)

1 = Initiate Stop condition on SDAx and SCLx pins. Hardware clear at end of master Stop sequence.

0 = Stop condition not in progress

bit 1 **RSEN:** Repeated Start Condition Enable bit (when operating as I²C master)

1 = Initiate Repeated Start condition on SDAx and SCLx pins. Hardware clear at end of master Repeated Start sequence.

0 = Repeated Start condition not in progress

bit 0 **SEN:** Start Condition Enable bit (when operating as I²C master)

1 = Initiate Start condition on SDAx and SCLx pins. Hardware clear at end of master Start sequence.

0 = Start condition not in progress

REGISTER 19-1: CICTRL1: ECAN™ MODULE CONTROL REGISTER 1

U-0	U-0	R/W-0	R/W-0	r-0	R/W-1	R/W-0	R/W-0
_	_	CSIDL	ABAT	_		REQOP<2:0>	
bit 15							bit 8

R-1	R-0	R-0	U-0	R/W-0	U-0	U-0	R/W-0
	OPMODE<2:0>		_	CANCAP	_	_	WIN
bit 7							bit 0

Legend: r = Bit is Reserved

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0' bit 13 **CSIDL:** Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12 ABAT: Abort All Pending Transmissions bit

1 = Signal all transmit buffers to abort transmission

0 = Module will clear this bit when all transmissions are aborted

bit 11 Reserved: Do not use

bit 10-8 **REQOP<2:0>:** Request Operation Mode bits

111 = Set Listen All Messages mode

110 = Reserved – do not use

101 = Reserved – do not use

100 = Set Configuration mode

011 = Set Listen Only Mode

010 = Set Loopback mode

001 = Set Disable mode

000 = Set Normal Operation mode

bit 7-5 **OPMODE<2:0>:** Operation Mode bits

111 = Module is in Listen All Messages mode

110 = Reserved

101 = Reserved

100 = Module is in Configuration mode

011 = Module is in Listen Only mode

010 = Module is in Loopback mode

001 = Module is in Disable mode

000 = Module is in Normal Operation mode

bit 4 Unimplemented: Read as '0'

bit 3 CANCAP: CAN Message Receive Timer Capture Event Enable bit

1 = Enable input capture based on CAN message receive

0 = Disable CAN capture

bit 2-1 **Unimplemented:** Read as '0'

bit 0 WIN: SFR Map Window Select bit

1 = Use filter window

0 = Use buffer window

REGISTER 19-11: CIFEN1: ECAN™ MODULE ACCEPTANCE FILTER ENABLE REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
FLTEN15	FLTEN14	FLTEN13	FLTEN12	FLTEN11	FLTEN10	FLTEN9	FLTEN8
bit 15							bit 8

R/W-1								
FLTEN7	FLTEN6	FLTEN5	FLTEN4	FLTEN3	FLTEN2	FLTEN1	FLTEN0	
bit 7								

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-0 FLTENn: Enable Filter n (0-15) to Accept Messages bits

1 = Enable Filter n0 = Disable Filter n

REGISTER 20-7: ADxCSSH: ADCx INPUT SCAN SELECT REGISTER HIGH(1,2)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CSS31	CSS30	CSS29	CSS28	CSS27	CSS26	CSS25	CSS24
bit 15							bit 8

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| CSS23 | CSS22 | CSS21 | CSS20 | CSS19 | CSS18 | CSS17 | CSS16 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-0 CSS<31:16>: ADC Input Scan Selection bits

1 = Select ANx for input scan0 = Skip ANx for input scan

Note 1: On devices without 32 analog inputs, all ADxCSSH bits may be selected by user. However, inputs selected for scan without a corresponding input on device will convert VREFL.

2: CSSx = ANx, where x = 16 through 31.

REGISTER 20-8: ADXCSSL: ADCx INPUT SCAN SELECT REGISTER LOW(1,2)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CSS15	CSS14	CSS13	CSS12	CSS11	CSS10	CSS9	CSS8
bit 15							bit 8

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| CSS7 | CSS6 | CSS5 | CSS4 | CSS3 | CSS2 | CSS1 | CSS0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-0 CSS<15:0>: ADC Input Scan Selection bits

1 = Select ANx for input scan0 = Skip ANx for input scan

Note 1: On devices without 16 analog inputs, all ADxCSSL bits may be selected by user. However, inputs selected for scan without a corresponding input on device will convert VREF-.

2: CSSx = ANx, where x = 0 through 15.

21.4 Watchdog Timer (WDT)

For PIC24HJXXXGPX06A/X08A/X10A devices, the WDT is driven by the LPRC oscillator. When the WDT is enabled, the clock source is also enabled.

The nominal WDT clock source from LPRC is 32 kHz. This feeds a prescaler than can be configured for either 5-bit (divide-by-32) or 7-bit (divide-by-128) operation. The prescaler is set by the WDTPRE Configuration bit. With a 32 kHz input, the prescaler yields a nominal WDT time-out period (TWDT) of 1 ms in 5-bit mode, or 4 ms in 7-bit mode.

A variable postscaler divides down the WDT prescaler output and allows for a wide range of time-out periods. The postscaler is controlled by the WDTPOST<3:0> Configuration bits (FWDT<3:0>) which allow the selection of a total of 16 settings, from 1:1 to 1:32,768. Using the prescaler and postscaler, time-out periods ranging from 1 ms to 131 seconds can be achieved.

The WDT, prescaler and postscaler are reset:

- · On any device Reset
- On the completion of a clock switch, whether invoked by software (i.e., setting the OSWEN bit after changing the NOSC bits) or by hardware (i.e., Fail-Safe Clock Monitor)
- When a PWRSAV instruction is executed (i.e., Sleep or Idle mode is entered)
- When the device exits Sleep or Idle mode to resume normal operation
- By a CLRWDT instruction during normal execution

If the WDT is enabled, it will continue to run during Sleep or Idle modes. When the WDT time-out occurs, the device will wake the device and code execution will continue from where the PWRSAV instruction was executed. The corresponding SLEEP or IDLE bits (RCON<3,2>) will need to be cleared in software after the device wakes up.

The WDT flag bit, WDTO (RCON<4>), is not automatically cleared following a WDT time-out. To detect subsequent WDT events, the flag must be cleared in software.

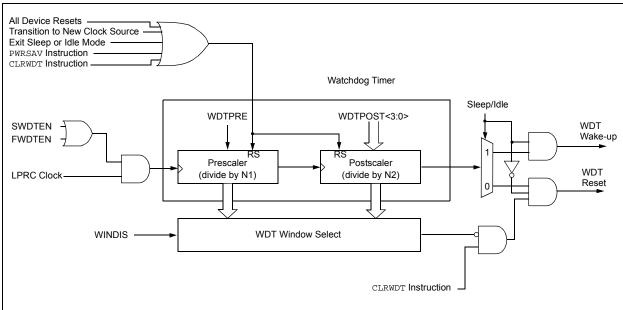
Note: The CLRWDT and PWRSAV instructions clear the prescaler and postscaler counts when executed.

The WDT is enabled or disabled by the FWDTEN Configuration bit in the FWDT Configuration register. When the FWDTEN Configuration bit is set, the WDT is always enabled.

The WDT can be optionally controlled in software when the FWDTEN Configuration bit has been programmed to '0'. The WDT is enabled in software by setting the SWDTEN control bit (RCON<5>). The SWDTEN control bit is cleared on any device Reset. The software WDT option allows the user to enable the WDT for critical code segments and disable the WDT during non-critical segments for maximum power savings.

Note: If the WINDIS bit (FWDT<6>) is cleared, the CLRWDT instruction should be executed by the application software only during the last 1/4 of the WDT period. This CLRWDT window can be determined by using a timer. If a CLRWDT instruction is executed before this window, a WDT Reset occurs.

FIGURE 21-2: WDT BLOCK DIAGRAM



22.0 INSTRUCTION SET SUMMARY

Note:

This data sheet summarizes the features of the PIC24HJXXXGPX06A/X08A/X10A families of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the related section in the "dsPIC33F/PIC24H Family Reference Manual", which is available from the Microchip web site (www.microchip.com).

The PIC24H instruction set is identical to that of the PIC24F, and is a subset of the dsPIC30F/33F instruction set.

Most instructions are a single program memory word (24 bits). Only three instructions require two program memory locations.

Each single-word instruction is a 24-bit word, divided into an 8-bit opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into five basic categories:

- · Word or byte-oriented operations
- · Bit-oriented operations
- · Literal operations
- · DSP operations
- Control operations

Table 22-1 shows the general symbols used in describing the instructions.

The PIC24H instruction set summary in Table 22-2 lists all the instructions, along with the status flags affected by each instruction.

Most word or byte-oriented W register instructions (including barrel shift instructions) have three operands:

- The first source operand which is typically a register 'Wb' without any address modifier
- The second source operand which is typically a register 'Ws' with or without an address modifier
- The destination of the result which is typically a register 'Wd' with or without an address modifier

However, word or byte-oriented file register instructions have two operands:

- · The file register specified by the value 'f'
- The destination, which could either be the file register 'f' or the W0 register, which is denoted as 'WREG'

Most bit-oriented instructions (including simple rotate/shift instructions) have two operands:

- The W register (with or without an address modifier) or file register (specified by the value of 'Ws' or 'f')
- The bit in the W register or file register (specified by a literal value or indirectly by the contents of register 'Wb')

The literal instructions that involve data movement may use some of the following operands:

- A literal value to be loaded into a W register or file register (specified by the value of 'k')
- The W register or file register where the literal value is to be loaded (specified by 'Wb' or 'f')

However, literal instructions that involve arithmetic or logical operations use some of the following operands:

- The first source operand which is a register 'Wb' without any address modifier
- The second source operand which is a literal value
- The destination of the result (only if not the same as the first source operand) which is typically a register 'Wd' with or without an address modifier

The control instructions may use some of the following operands:

- A program memory address
- The mode of the table read and table write instructions

All instructions are a single word, except for certain double word instructions, which were made double word instructions so that all the required information is available in these 48 bits. In the second word, the 8 MSbs are '0's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

Most single-word instructions are executed in a single instruction cycle, unless a conditional test is true, or the program counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles with the additional instruction cycle(s) executed as a NOP. Notable exceptions are the BRA (unconditional/computed branch), indirect CALL/GOTO, all table reads and writes and RETURN/RETFIE instructions, which are single-word instructions but take two or three cycles. Certain instructions that involve skipping over the subsequent instruction require either two or three cycles if the skip is performed, depending on whether the instruction being skipped is a single-word or double word instruction. Moreover, double word moves require two cycles. The double word instructions execute in two instruction cycles.

Note: For more details on the instruction set, refer to the "16-bit MCU and DSC Programmer's Reference Manual" (DS70157).

TABLE 24-32: SPIX SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 0, SMP = 0) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.4V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended				
Param No.	Symbol	Characteristic ⁽¹⁾	Min	Typ ⁽²⁾	Max	Units	Conditions
SP70	TscP	Maximum SCK Input Frequency	_	_	15	MHz	See Note 3
SP72	TscF	SCKx Input Fall Time	_	_	_	ns	See parameter DO32 and Note 4
SP73	TscR	SCKx Input Rise Time	_	_	_	ns	See parameter DO31 and Note 4
SP30	TdoF	SDOx Data Output Fall Time	_	_	_	ns	See parameter DO32 and Note 4
SP31	TdoR	SDOx Data Output Rise Time	_	_	_	ns	See parameter DO31 and Note 4
SP35	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	_	6	20	ns	_
SP36	TdoV2scH, TdoV2scL	SDOx Data Output Setup to First SCKx Edge	30	_	_	ns	_
SP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	30	_	_	ns	_
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	30	_	_	ns	_
SP50	TssL2scH, TssL2scL	SSx ↓ to SCKx ↑ or SCKx Input	120	_	_	ns	_
SP51	TssH2doZ	SSx ↑ to SDOx Output High-Impedance ⁽⁴⁾	10	_	50	ns	_
SP52	TscH2ssH TscL2ssH	SSx after SCKx Edge	1.5 Tcy + 40	_	_	ns	See Note 4
SP60	TssL2doV	SDOx Data Output Valid after SSx Edge	_	_	50	ns	_

- **Note 1:** These parameters are characterized, but are not tested in manufacturing.
 - 2: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.
 - **3:** The minimum clock period for SCKx is 66.7 ns. Therefore, the SCK clock generated by the Master must not violate this specificiation.
 - 4: Assumes 50 pF load on all SPIx pins.

TABLE 24-39: ADC MODULE SPECIFICATIONS

AC CHARACTERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended									
Param No.	Symbo I	Characteristic	Min.	Тур	Max.	Units	Conditions				
	Device Supply										
AD01	AVDD	Module VDD Supply	Greater of VDD – 0.3 or 3.0	_	Lesser of VDD + 0.3 or 3.6	V	_				
AD02	AVss	Module Vss Supply	Vss - 0.3	_	Vss + 0.3	V	_				
			Referen	ce Inpu	ts						
AD05	VREFH	Reference Voltage High	AVss + 2.5	_	AVDD	V					
AD05a			3.0	_	3.6	V	VREFH = AVDD VREFL = AVSS = 0				
AD06	VREFL	Reference Voltage Low	AVss	_	AVDD - 2.5	V					
AD06a			0	_	0	V	VREFH = AVDD VREFL = AVSS = 0				
AD07	VREF	Absolute Reference Voltage	2.5	_	3.6	V	VREF = VREFH - VREFL				
AD08	IREF	Current Drain	_	_	10	μА	ADC off				
AD08a	IAD	Operating Current	_	7.0 2.7	9.0 3.2	mA mA	10-bit ADC mode, See Note 1 12-bit ADC mode, See Note 1				
			Analo	g Input							
AD12	VINH	Input Voltage Range VINH	VINL	_	VREFH	V	This voltage reflects Sample and Hold Channels 0, 1, 2, and 3 (CH0-CH3), positive input				
AD13	VINL	Input Voltage Range VINL	VREFL	_	AVss + 1V	V	This voltage reflects Sample and Hold Channels 0, 1, 2, and 3 (CH0-CH3), negative input				
AD17	Rin	Recommended Imped- ance of Analog Voltage Source	_	_	200 200	Ω Ω	10-bit ADC 12-bit ADC				

Note 1: These parameters are not characterized or tested in manufacturing.

FIGURE 24-23: ADC CONVERSION (10-BIT MODE) TIMING CHARACTERISTICS (CHPS<1:0> = 01, SIMSAM = 0, ASAM = 0, SSRC<2:0> = 000)

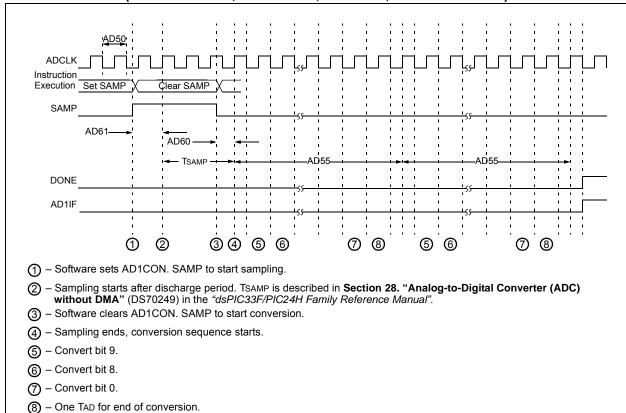
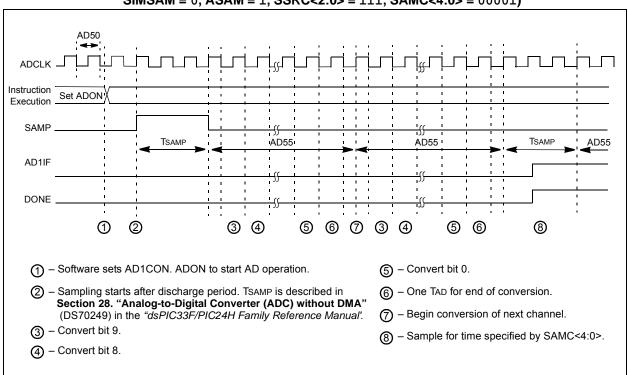
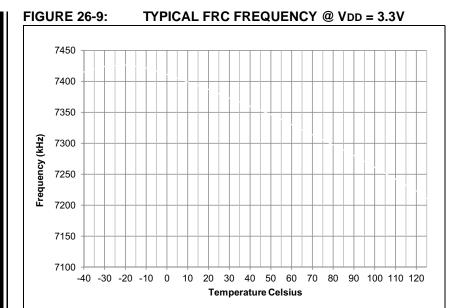
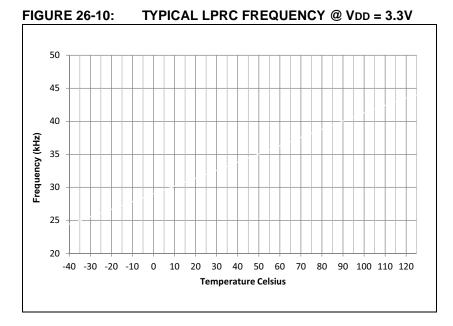


FIGURE 24-24: ADC CONVERSION (10-BIT MODE) TIMING CHARACTERISTICS (CHPS<1:0> = 01, SIMSAM = 0, ASAM = 1, SSRC<2:0> = 111, SAMC<4:0> = 00001)







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